

☆TDK Multilayer Ceramic Chip Capacitors

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Creation Date: April 22, 2014

C1608X7R1C334K080AC (TDK item description: C1608X7R1C334KT****)

Applications



Commercial Grade



Please refer to Part No. CGA3E1X7R1C334K080AC for automotive use.

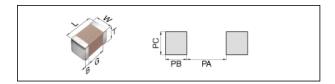
Feature

General

General (Up to 50V)

Series

C1608 [EIA CC0603]











Size		
Length(L)	1.60mm +/-0.10mm	
Width(W)	0.80mm +/-0.10mm	
Thickness(T)	0.80mm +/-0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern(PA)	0.70 to 1.00mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	0.80 to 1.00mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	0.60 to 0.80mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	330nF +/-10%	
Rated Voltage	16Vdc	
Temperature Characteristic	X7R(+/-15%)	
Dissipation Factor	5% Max.	
Insulation Resistance	303MΩ Min.	

Other	
Soldering Method	Reflow, Flow
AEC Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000Pcs Min.

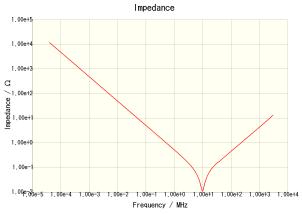
[•]This PDF document was created based on the data listed on the TDK Corporation website.

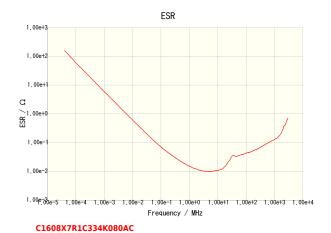
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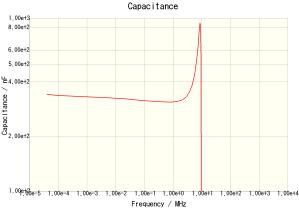
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)

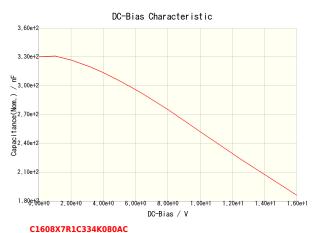




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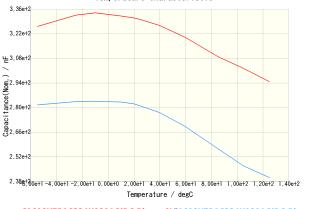




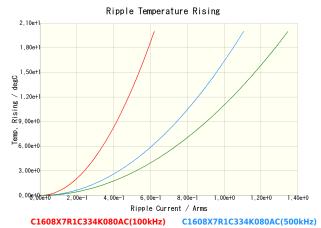


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Temperature Characteristic



C1608X7R1C334K080AC(DC Bias = 0V)1608X7R1C334K080AC(DC Bias = 8V)

C1608X7R1C334K080AC(1MHz)

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